PCN Number:	Number: 20150629000			F	PCN Date:	07/10/2015			
Title: Datasheet un							, ,		
Customer Contact:	PCN Manager		.01		De	nt. Ou	ality Services		
Change Type:	1 CIT Manager					pt. Qui	ancy Services		
			Docian		\Box	Wafer Bur	on Cita		
Assembly Site		\square	Design Data Chaot			Wafer Bun			
Assembly Process		\vdash	Data Sheet		$\frac{\square}{\square}$	Wafer Bur			
Assembly Material Mechanical Specif		\vdash	Part number change		$\frac{\square}{\square}$	Wafer Bump Process Wafer Fab Site			
		+	Test Site		H				
Packing/Shipping/Labeling Test Process						Wafer Fab Materials			
Wafer Fab Process									
			PCN Details						
Description of Change									
Texas Instruments Inco	orporated is a	ann	ouncing an information	only	/ no	tification et	С.		
The product datachest	(a) ia baina u	d -	stad as suppressized bal						
The product datasneet	(s) is being u	ipaa	ated as summarized bel	ow.					
The following change h	ictory provid	100 1	further details						
The following change h	listory provid	ies i	further details.						
ŢEXAS									
Instruments							TPS23861		
www.ti.com				SLUS	SBX9C	-MARCH 2014-RE			
Changes from Revision B (A	April 2015) to Rev	risior	ı C				Page		
	• •								
•	Added Figure 5								
Added Figure 6									
Changed Figure 36, Disconnected AIN pin from GND									
Added SHTDWN note.									
Added RESET note.									
Added Device Power On Initialization section									
Added note 2 to Table 10									
Added Port n Status Register note.									
Added Operating Mode Register Command note. 60									
Added Operating Mode Re	egister Bit Descrip	tion r	note				60		
Added Detect/Class Enable Register Command note									
Added Detect/Class Restart Register Command note									
	Added Power Enable Register Command note								
Added Power Enable Register Bit Descriptions note.									
Added Reset Register Command note									
Added Reset Register Bit Descriptions note.									
Changed Figure 45, Disconnected AIN pin from GND									
Changed Figure 47, Disconnected AIN pin from GND									
Changed Figure 48, Disconnected AIN pin from GND									
Changed Figure 49, Disconnected AIN pin from GND									
Changed Q _{Pn} description in Per Port Components									
Changed maximum VDD supply current from 10 mA to 6 mA in first paragraph and changed wording in second									
paragraph of VDD									
Added VPWR-RESET Sequencing									
The datasheet number will be changing.									
Device Family			Change From:	Change To:			nge To:		
TPS23861	TPS23861 SLUSBX9B SLUSBX9C					SBX9C			
				-					

These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TPS23861

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

TPS23861PW	TPS23861PWR
1113230011 W	I II JZJOUTI WIK

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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